



MiniSKiiP® 3 PIM	1200 V / 100 A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Features</p> <ul style="list-style-type: none"> Solderless interconnection Trench Fieldstop IGBT⁴ technology </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Target Applications</p> <ul style="list-style-type: none"> Industrial Motor Drives </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Types</p> <ul style="list-style-type: none"> V23990-K420-A40-PM </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">MiniSKiiP® 3 housing</p> </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Schematic</p> </div>

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Rectifier Diode				
Repetitive peak reverse voltage	V_{RRM}		1600	V
DC forward current	I_{FAV}		75	A
Surge (non-repetitive) forward current	I_{FSM}	$t_p = 10\text{ ms}$	500	A
I ² t-value	I^2t		1250	A ² s
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	119	W
Maximum Junction Temperature	T_{jmax}		150	°C
Inverter Switch / Brake Switch				
Collector-emitter breakdown voltage	V_{CE}		1200	V
DC collector current	I_C		100	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	300	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	301	W
Gate-emitter peak voltage	V_{GE}		±20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j = 150\text{ °C}$ $V_{GE} = 15\text{ V}$	10 800	μs V
Maximum Junction Temperature	T_{jmax}		175	°C

**Maximum Ratings** $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode / Brake Diode				
Repetitive peak reverse voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	79	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	300	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	171	W
Maximum Junction Temperature	T_{jmax}		175	°C

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{op}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	5500	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance		With std lid For more information see handling instructions	6,3	mm
Clearance		With std lid For more information see handling instructions	6,3	mm
Comparative Tracking Index	CTI		>200	

*100% tested in production



Characteristic Values

Parameter	Symbol	Conditions					Value			Unit								
		V_{GE} [V]	V_{GS} [V]	V_r [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_F [A]	I_D [A]		T_j [°C]	Min	Typ	Max				
Rectifier Diode																		
Forward voltage	V_F					35	25 125				0,8	0,97 0,88	1,35	V				
Threshold voltage (for power loss calc. only)	V_{to}						25 125					0,85 0,71		V				
Slope resistance (for power loss calc. only)	r_t						25 125					0,0035 0,0047		Ω				
Reverse current	I_r				1500		25 125						0,1 1,1	mA				
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 2,5$ W/mK (HPTP)										0,59		K/W				
Inverter Switch / Brake Switch																		
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$				0,0038	25				5	5,8	6,5	V				
Collector-emitter saturation voltage	V_{CESat}		15			100	25 150			1,6	1,92 2,33	2,2		V				
Collector-emitter cut-off current incl. Diode	I_{CES}		0	1200			25						0,12	mA				
Gate-emitter leakage current	I_{GES}		20	0			25						600	nA				
Integrated Gate resistor	R_{gint}											7,5		Ω				
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4\Omega$ $R_{gon} = 4\Omega$	± 15	600	100		25					204		ns				
Rise time	t_r						150					35				216		
Turn-off delay time	$t_{d(off)}$						25					42						
Fall time	t_f						150					296						
Turn-on energy loss	E_{on}						150					384						
Turn-off energy loss	E_{off}	25					78						mWs					
		150					112											
Input capacitance	C_{ies}											6150		pF				
Output capacitance	C_{oss}	$f = 1$ MHz	0	25			25					405						
Reverse transfer capacitance	C_{rss}											345						
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 2,5$ W/mK (HPTP)										0,32		K/W				
Inverter Diode / Brake Diode																		
Diode forward voltage	V_F					100	25 150				1,5	2,47 2,46	2,7	V				
Peak reverse recovery current	I_{RRM}	$R_{gon} = 4\Omega$	± 15	600	100		25					68,3		A				
							150					91,3						
Reverse recovery time	t_{rr}						25					267						ns
							150					455						
Reverse recovered charge	Q_{rr}						25					5,69						μC
		150					15,08											
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	25					2761						A/μs					
		150					977											
Reverse recovered energy	E_{rec}	25					1,87						mWs					
		150					5,42											
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 2,5$ W/mK (HPTP)										0,56		K/W				



Characteristic Values

Parameter	Symbol	Conditions					Value			Unit			
		V_{GE} [V]	V_{GS} [V]	V_r [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_F [A]	I_D [A]		T_j [°C]	Min	Typ
Thermistor													
Rated resistance	R								25		1000		Ω
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100}=1670 \Omega$							100	-3		3	%
R_{100}	P								100		1670		Ω
Power dissipation constant									25				mW/K
A-value	$B_{(25/50)}$	Tol. %							25		$7,635 \cdot 10^{-3}$		1/K
B-value	$B_{(25/100)}$	Tol. %							25		$1,731 \cdot 10^{-5}$		1/K ²
Vincotech NTC Reference												E	

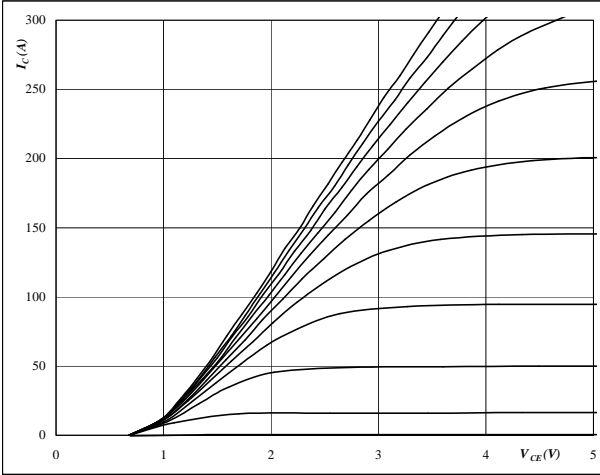


Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$



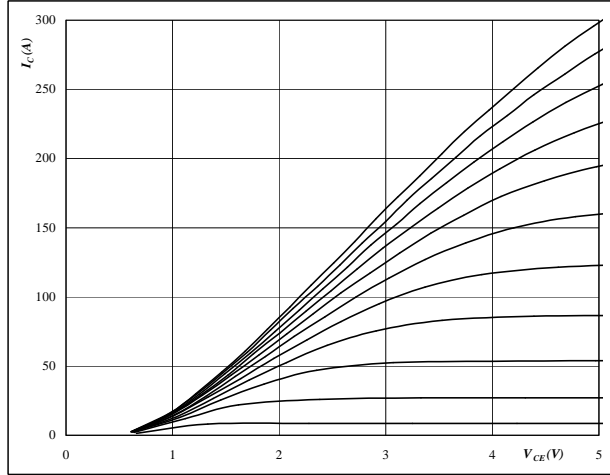
At

$t_p = 250 \mu s$
 $T_j = 25 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$



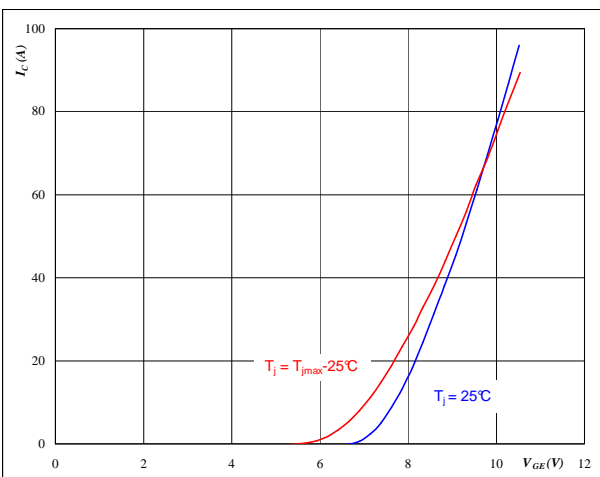
At

$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$



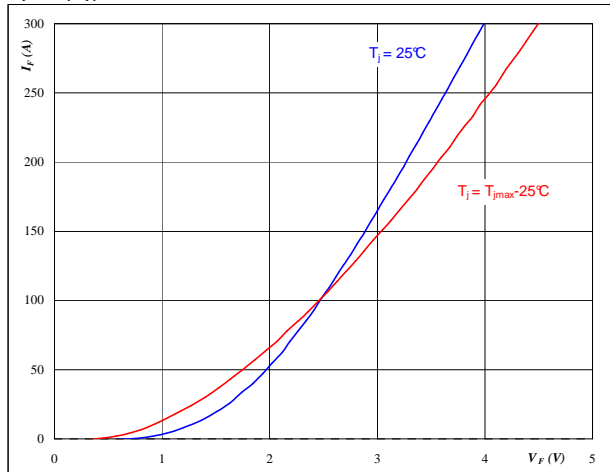
At

$t_p = 250 \mu s$
 $V_{CE} = 10 V$

figure 4. FWD

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



At

$t_p = 250 \mu s$

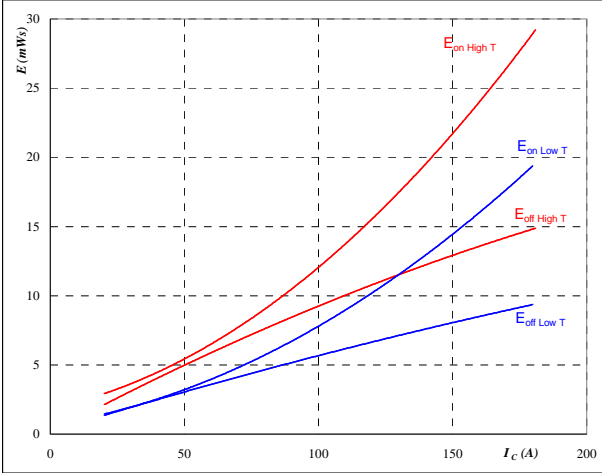


Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 5. IGBT

Typical switching energy losses
as a function of collector current

$$E = f(I_C)$$



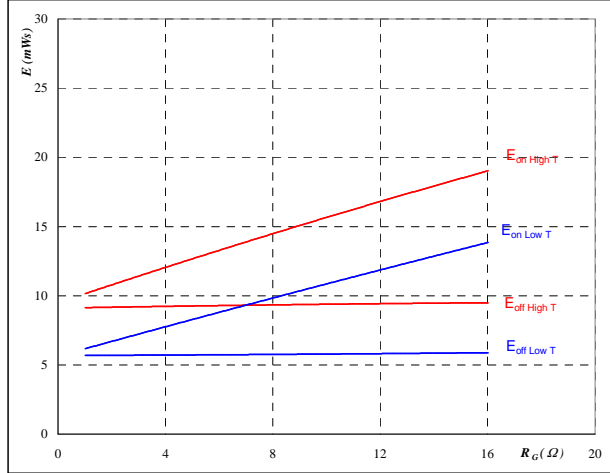
With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $R_{gon} = 4 \text{ } \Omega$
- $R_{goff} = 4 \text{ } \Omega$

figure 6. IGBT

Typical switching energy losses
as a function of gate resistor

$$E = f(R_G)$$



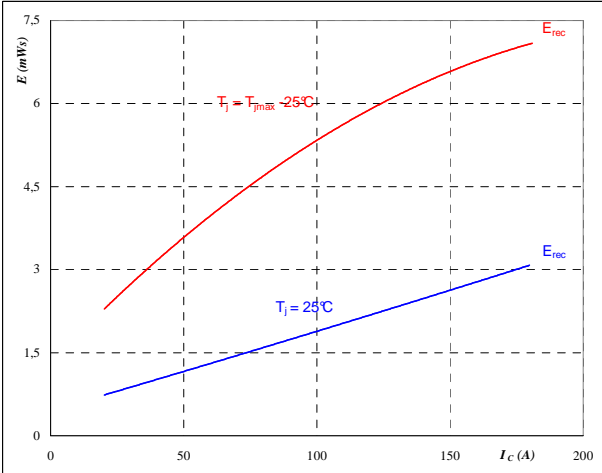
With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $I_C = 100 \text{ A}$

figure 7. IGBT

Typical reverse recovery energy loss
as a function of collector current

$$E_{rec} = f(I_C)$$



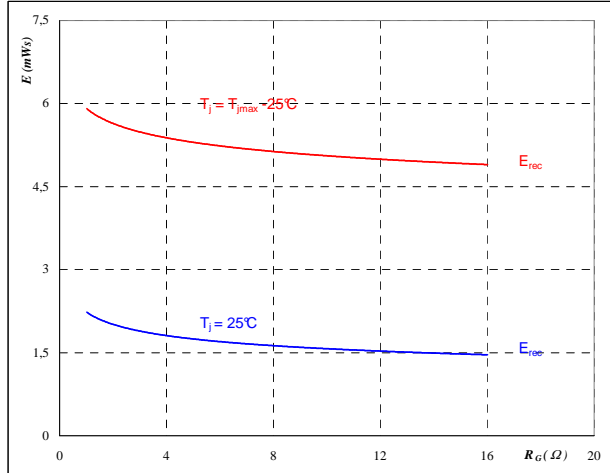
With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $R_{gon} = 4 \text{ } \Omega$

figure 8. IGBT

Typical reverse recovery energy loss
as a function of gate resistor

$$E_{rec} = f(R_G)$$



With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $I_C = 100 \text{ A}$

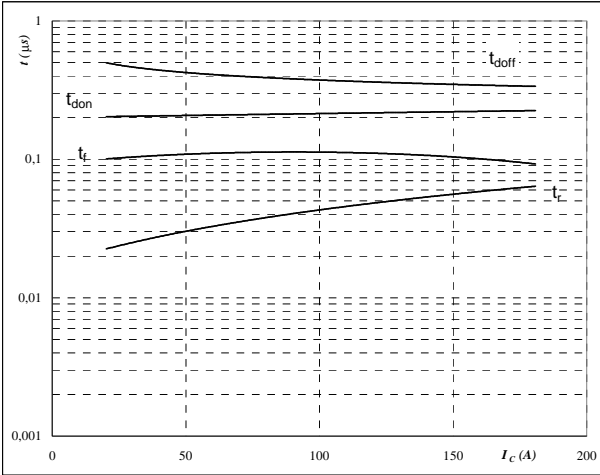


Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 9. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



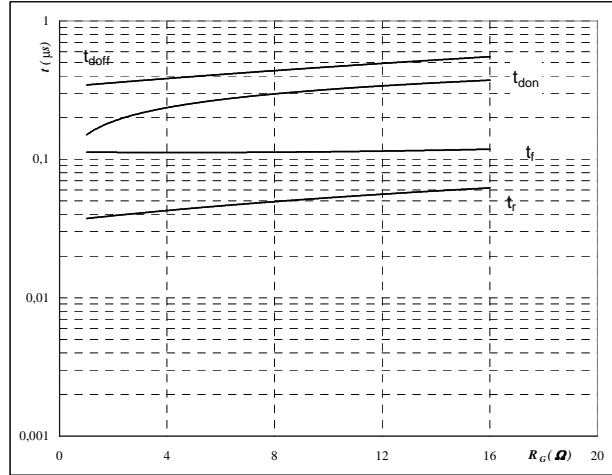
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

figure 10. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



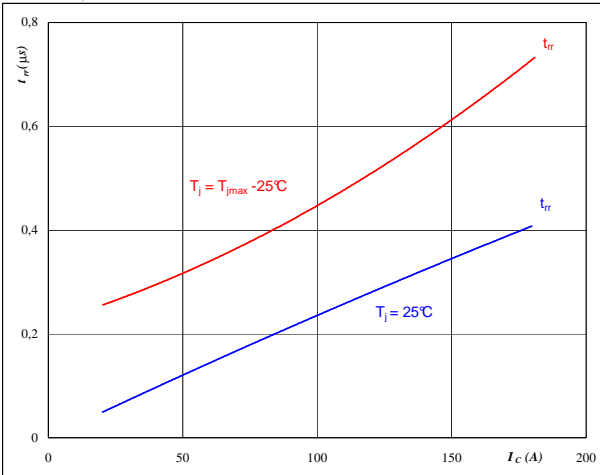
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	100	A

figure 11. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



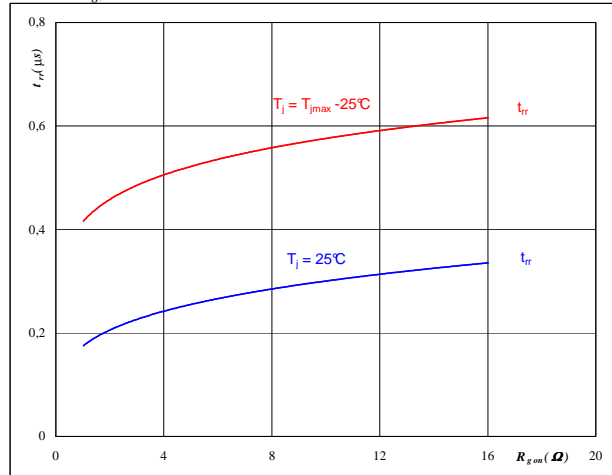
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

figure 12. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	100	A
$V_{GE} =$	±15	V

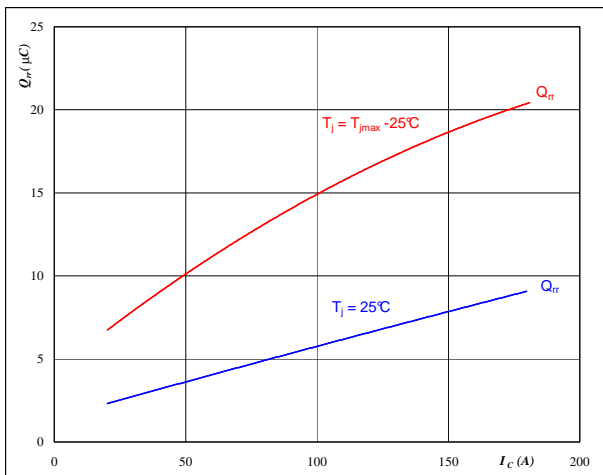


Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 13. FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$



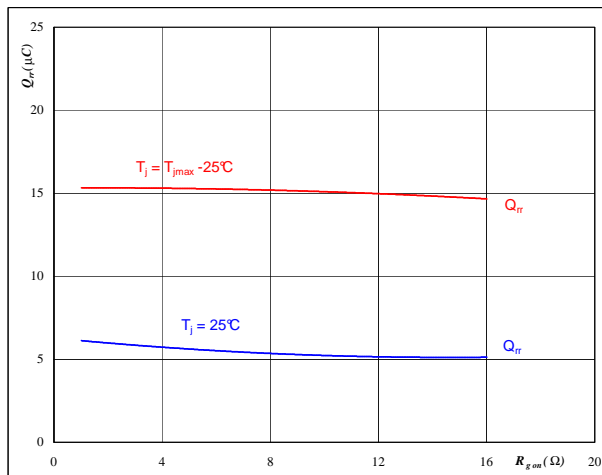
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

figure 14. FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$



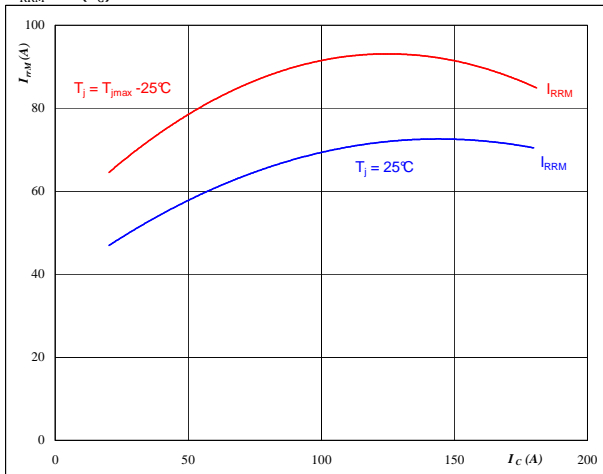
At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	100	A
$V_{GE} =$	±15	V

figure 15. FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$



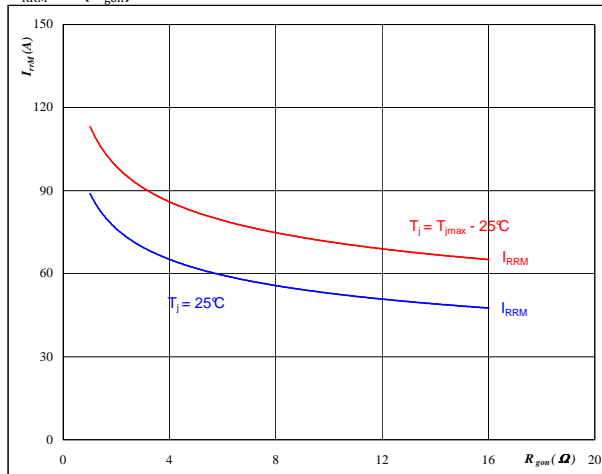
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

figure 16. FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	100	A
$V_{GE} =$	±15	V



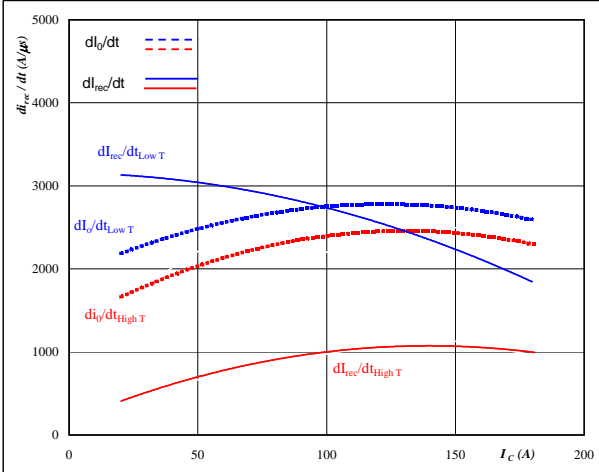
Vincotech

Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 17. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$dI_0/dt, dI_{rec}/dt = f(I_C)$$

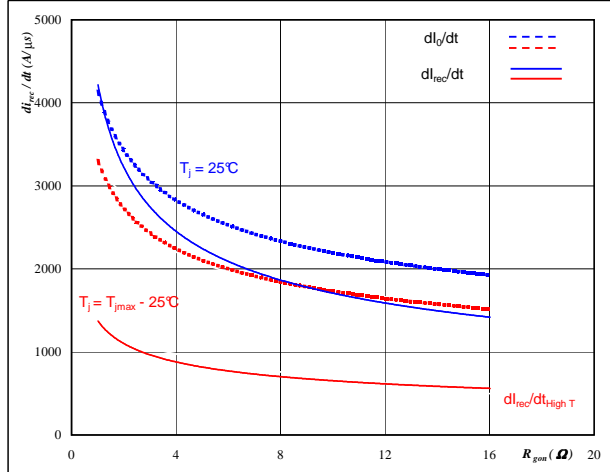


At
 $T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$

figure 18. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

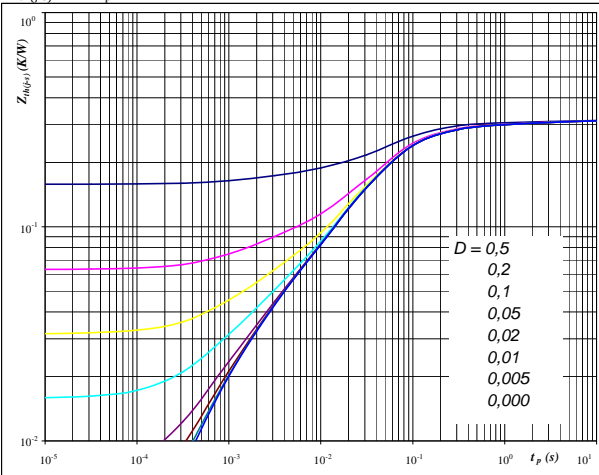


At
 $T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_R = 600 \text{ V}$
 $I_F = 100 \text{ A}$
 $V_{GE} = \pm 15 \text{ V}$

figure 19. IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



At
 $D = t_p / T$
 $R_{th(j-s)} = 0,32 \text{ K/W}$

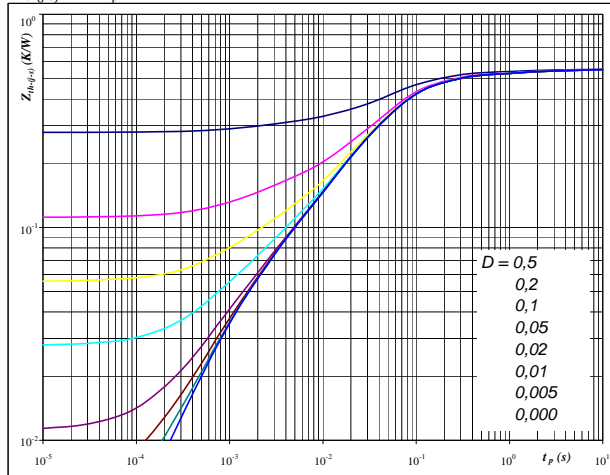
IGBT thermal model values

R (K/W)	Tau (s)
1,18E-02	2,36E+00
2,20E-02	2,01E-01
5,85E-02	3,58E-02
1,69E-01	1,20E-02
3,16E-02	2,33E-03
2,12E-02	3,57E-04
1,46E-03	1,7E-04

figure 20. FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



At
 $D = t_p / T$
 $R_{th(j-s)} = 0,56 \text{ K/W}$

FWD thermal model values

R (K/W)	Tau (s)
2,07E-02	4,15E+00
3,89E-02	3,54E-01
1,03E-01	6,31E-02
2,99E-01	2,11E-02
5,56E-02	4,10E-03
3,73E-02	6,30E-04
2,57E-03	3,0E-04



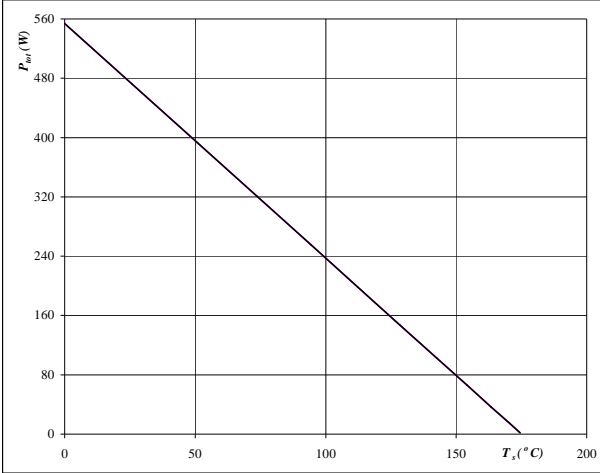
Vincotech

Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 21. IGBT

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

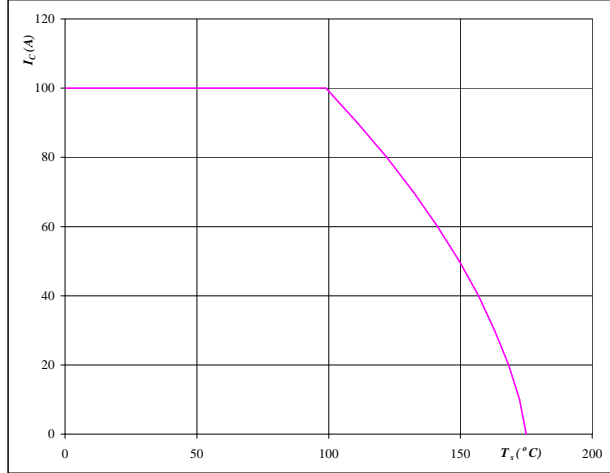


At
T_j = 175 °C

figure 22. IGBT

Collector current as a function of heatsink temperature

$$I_C = f(T_s)$$

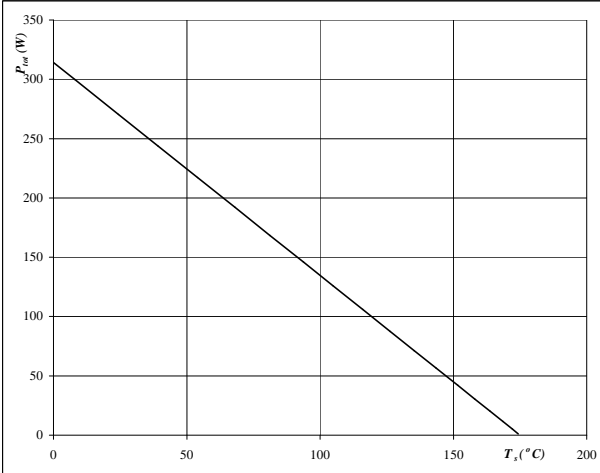


At
T_j = 175 °C
V_{GE} = 15 V

figure 23. FWD

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

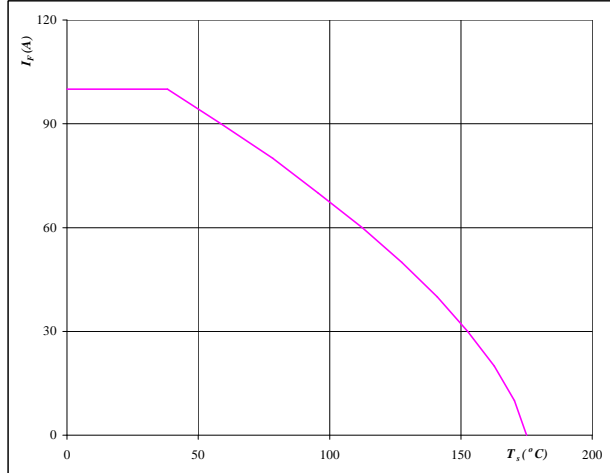


At
T_j = 175 °C

figure 24. FWD

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$



At
T_j = 175 °C

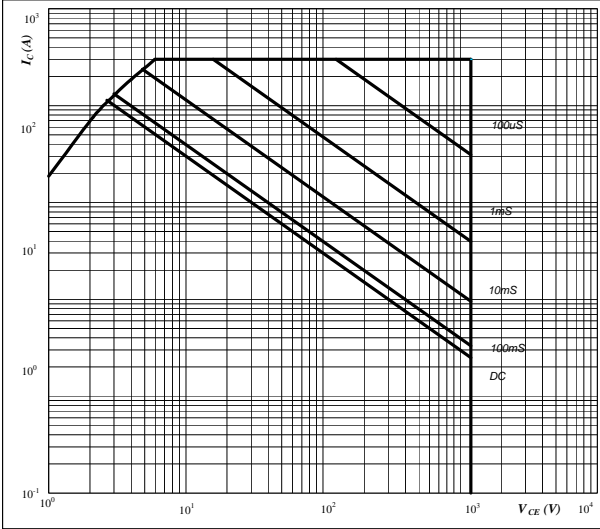


Inverter Switch / Brake Switch / Inverter Diode / Brake Diode

figure 25. IGBT

Safe operating area as a function of collector-emitter voltage

$$I_C = f(V_{CE})$$

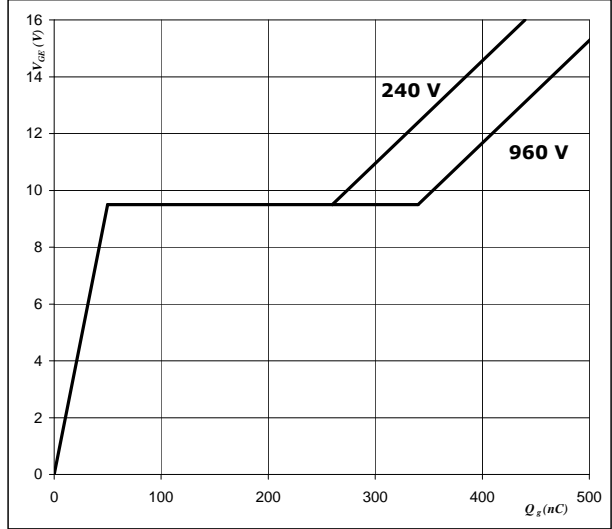


At
 $D =$ single pulse
 $T_s =$ 80 °C
 $V_{GE} =$ ±15 V
 $T_j = T_{jmax}$

figure 26. IGBT

Gate voltage vs Gate charge

$$V_{GE} = f(Q_g)$$



At
 $I_C =$ 100 A

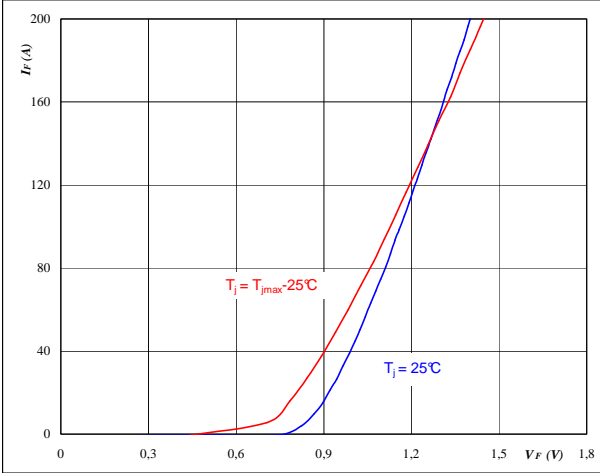


Rectifier Diode

figure 1. Diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

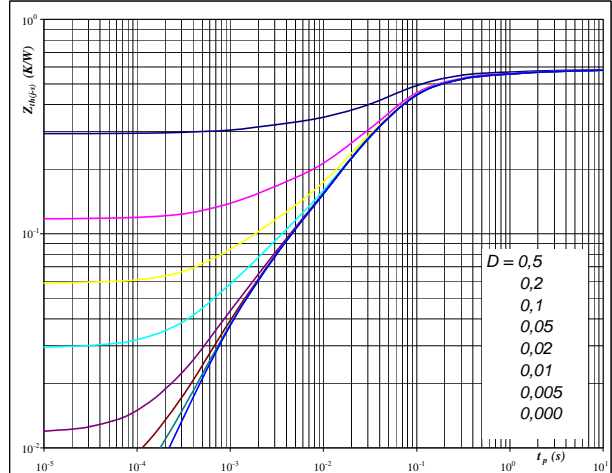


At
 $t_p = 250 \mu s$

figure 2. Diode

Diode transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$

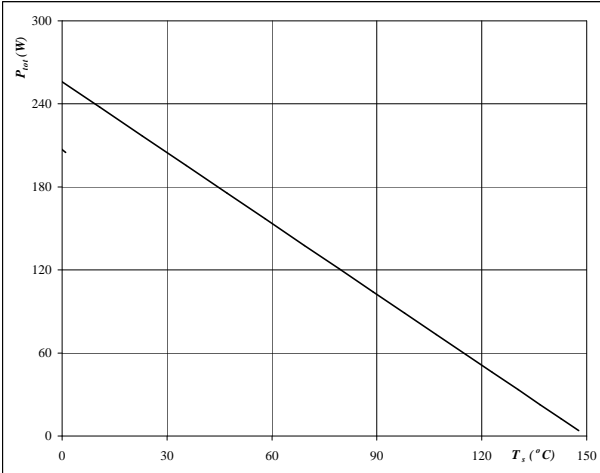


At
 $D = t_p / T$
 $R_{th(j-s)} = 0,59 \text{ K/W}$

figure 3. Diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_s)$

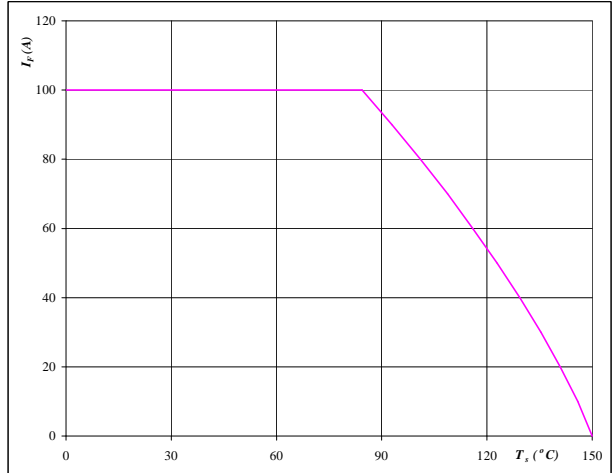


At
 $T_j = 150 \text{ °C}$

figure 4. Diode

Forward current as a function of heatsink temperature

$I_F = f(T_s)$



At
 $T_j = 150 \text{ °C}$

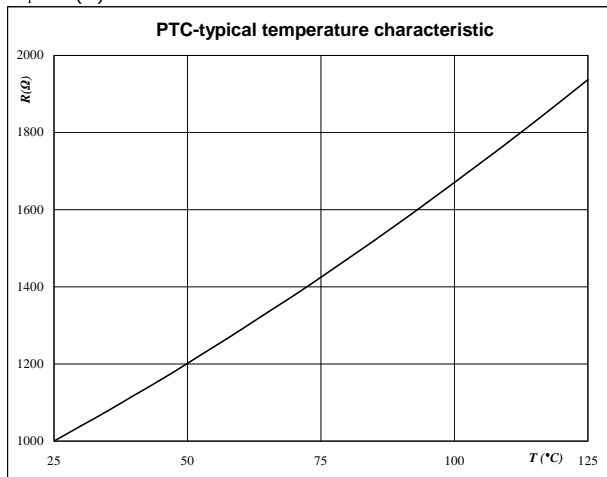


Thermistor

figure 1. Thermistor

**Typical PTC characteristic
as a function of temperature**

$$R_T = f(T)$$





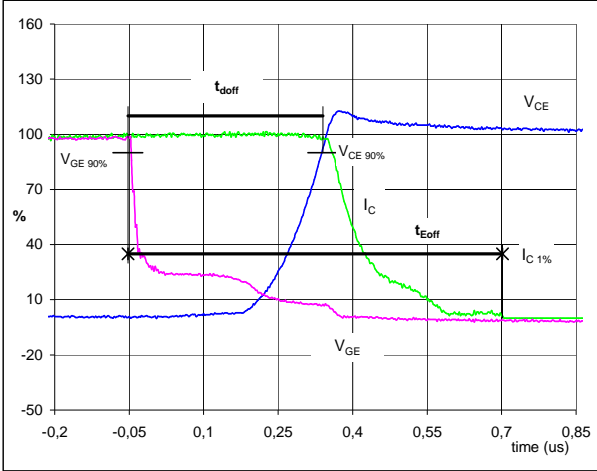
Switching Definitions Output Inverter

General conditions

T_j	=	150 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

figure 1. IGBT

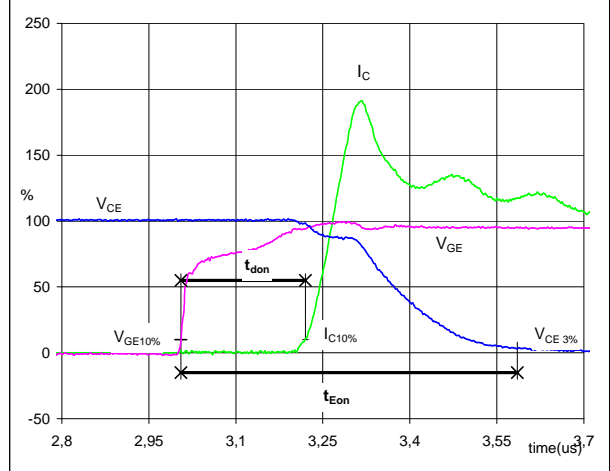
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
(t_{Eoff} = integrating time for E_{off})



V_{GE} (0%) =	-15	V
V_{GE} (100%) =	15	V
V_C (100%) =	600	V
I_C (100%) =	100	A
t_{doff} =	0,38	μs
t_{Eoff} =	0,75	μs

figure 2. IGBT

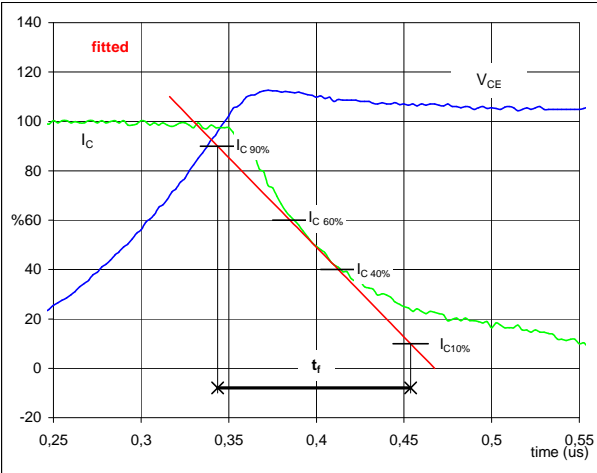
Turn-on Switching Waveforms & definition of t_{donr} , t_{Eon}
(t_{Eon} = integrating time for E_{on})



V_{GE} (0%) =	-15	V
V_{GE} (100%) =	15	V
V_C (100%) =	600	V
I_C (100%) =	100	A
t_{don} =	0,22	μs
t_{Eon} =	0,58	μs

figure 3. IGBT

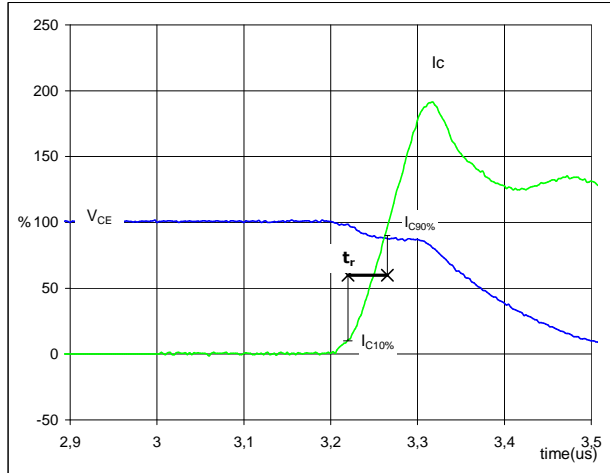
Turn-off Switching Waveforms & definition of t_f



V_C (100%) =	600	V
I_C (100%) =	100	A
t_f =	0,11	μs

figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

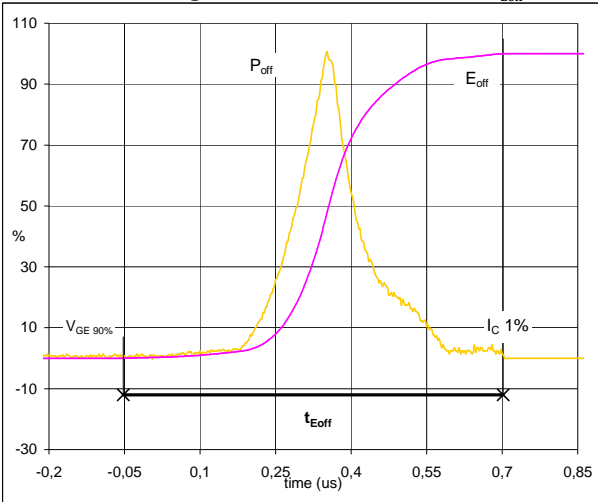


V_C (100%) =	600	V
I_C (100%) =	100	A
t_r =	0,04	μs



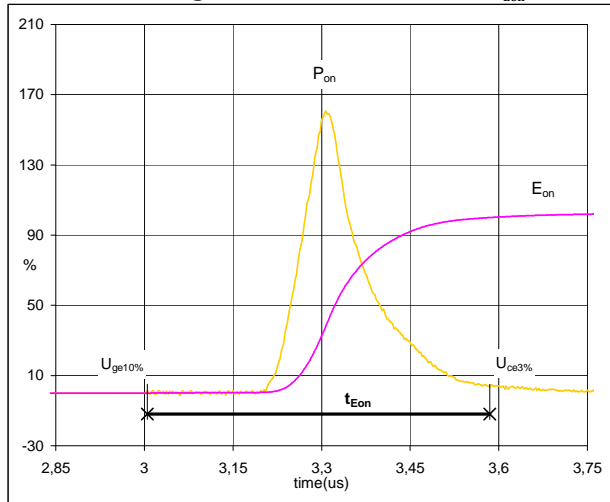
Switching Definitions Output Inverter

figure 5. IGBT
Turn-off Switching Waveforms & definition of t_{Eoff}



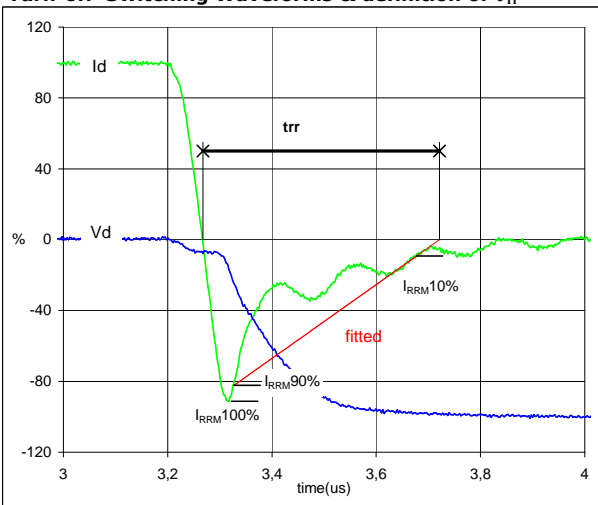
$P_{off} (100\%) = 60,10 \text{ kW}$
 $E_{off} (100\%) = 9,25 \text{ mJ}$
 $t_{Eoff} = 0,75 \text{ } \mu\text{s}$

figure 6. IGBT
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on} (100\%) = 60,10 \text{ kW}$
 $E_{on} (100\%) = 12,12 \text{ mJ}$
 $t_{Eon} = 0,58 \text{ } \mu\text{s}$

figure 8. IGBT
Turn-off Switching Waveforms & definition of t_{tr}



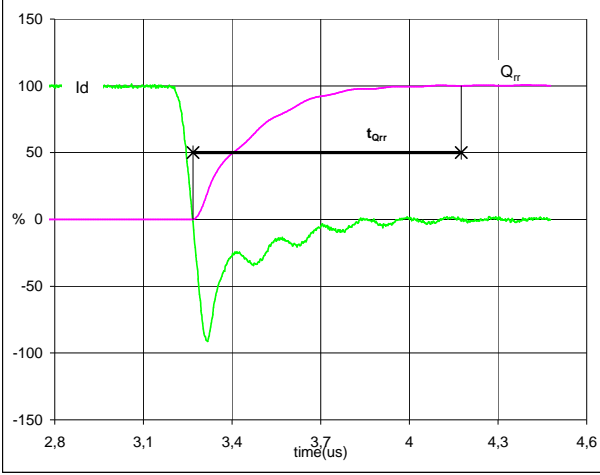
$V_d (100\%) = 600 \text{ V}$
 $I_d (100\%) = 100 \text{ A}$
 $I_{RRM} (100\%) = -91 \text{ A}$
 $t_{tr} = 0,46 \text{ } \mu\text{s}$



Switching Definitions Output Inverter

figure 9. FWD

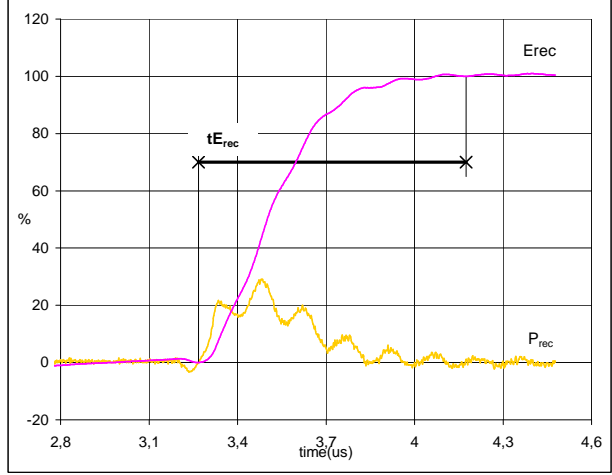
Turn-on Switching Waveforms & definition of t_{Qrr}
(t_{Qrr} = integrating time for Q_{rr})



I_d (100%) =	100	A
Q_{rr} (100%) =	15,08	μC
t_{Qrr} =	0,91	μs

figure 10. FWD

Turn-on Switching Waveforms & definition of t_{Erec}
(t_{Erec} = integrating time for E_{rec})

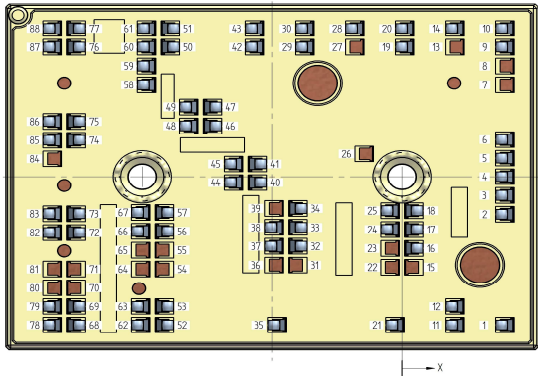


P_{rec} (100%) =	60,10	kW
E_{rec} (100%) =	5,42	mJ
t_{Erec} =	0,91	μs

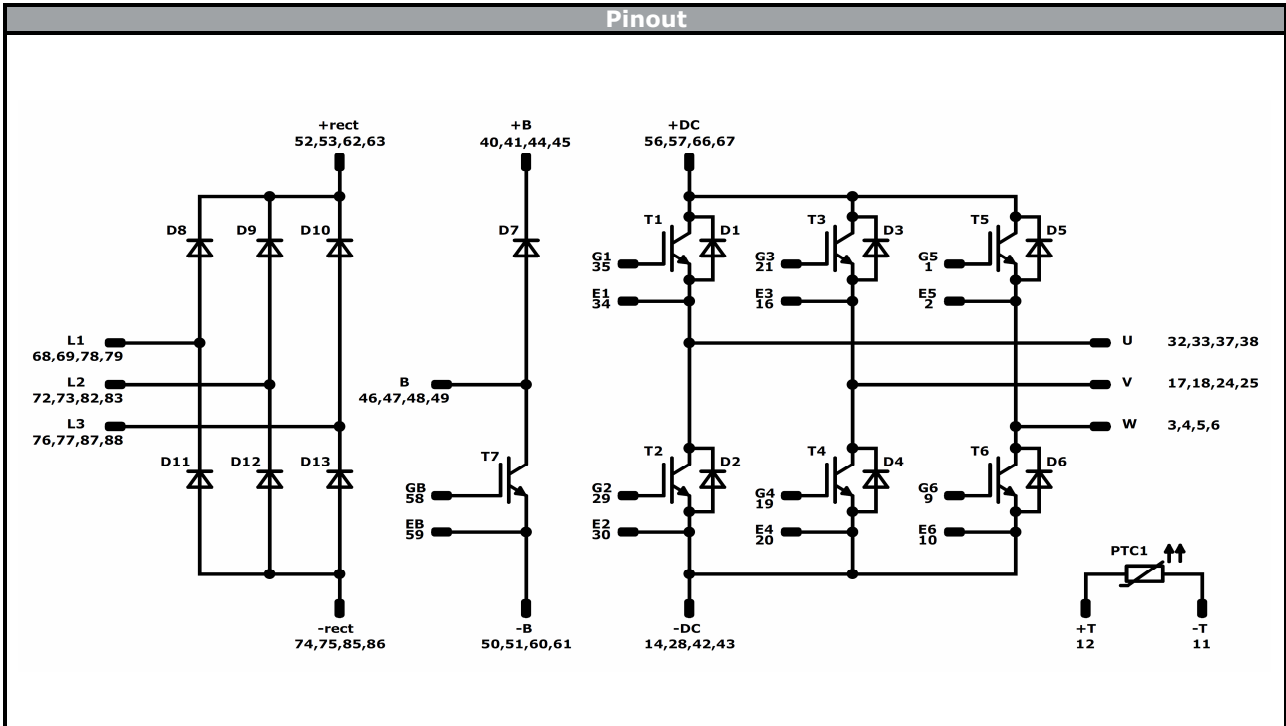


Ordering Code & Marking							
Version				Ordering Code			
With std lid (6.5mm height) + no thermal grease				V23990-K420-A40-/0A/-PM			
With thin lid (2.8mm height) + no thermal grease				V23990-K420-A40-/0B/-PM			
With std lid (6.5mm height) + thermal grease (0,8 W/mK, P12, silicone-based)				V23990-K420-A40-/1A/-PM			
With thin lid (2.8mm height) + thermal grease (0,8 W/mK, P12, silicone-based)				V23990-K420-A40-/1B/-PM			
With std lid (6.5mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free)				V23990-K420-A40-/4A/-PM			
With thin lid (2.8mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free)				V23990-K420-A40-/4B/-PM			
With std lid (6.5mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based)				V23990-K420-A40-/5A/-PM			
With thin lid (2.8mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based)				V23990-K420-A40-/5B/-PM			
	Text	VIN	Date code	Name&Ver	UL	Lot	Serial
		VIN	WWYY	NNNNNNVV	UL	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTTTVV	LLLLL	SSSS	WWYY		

Outline							
PCB pad table				PCB pad table			
Pin	X	Y	Function	Pin	X	Y	Function
1	15,83	-25,3	G5	45	-25,9	2,2	+B
2	15,83	-6,4	E5	46	10,82	8,74	B
3	15,83	-3,2	W	47	10,82	11,94	B
4	15,83	0	W	48	-32,82	8,74	B
5	15,83	3,2	W	49	-32,82	11,94	B
6	15,83	6,4	W	50	4,32	22,1	-B
7	Not assembled			51	4,32	25,3	-B
8	Not assembled			52	3,42	-25,3	+rect
9	15,83	22,1	G6	53	3,42	-22,1	+rect
10	15,83	25,3	E6	54	Not assembled		
11	8,13	-25,3	-T	55	Not assembled		
12	8,13	-22,1	+T	56	3,42	-9,3	+DC
13	Not assembled			57	3,42	-6,1	+DC
14	8,13	25,3	-DC	58	-39,32	15,7	GB
15	Not assembled			59	-39,32	18,9	EB
16	41,82	-12,18	E3	60	-39,32	22,1	-B
17	41,82	-8,98	V	61	-39,32	25,3	-B
18	41,82	-5,79	V	62	-40,22	-25,3	+rect
19	0,43	22,1	G4	63	-40,22	-22,1	+rect
20	0,43	25,3	E4	64	Not assembled		
21	-1,07	-25,3	G3	65	Not assembled		
22	Not assembled			66	-40,22	-9,3	+DC
23	Not assembled			67	-40,22	-6,09	+DC
24	-1,82	-8,98	V	68	-10,18	-25,3	L1
25	-1,82	-5,79	V	69	-10,18	-22,1	L1
26	Not assembled			70	Not assembled		
27	Not assembled			71	Not assembled		
28	-7,27	25,3	-DC	72	-10,18	-9,5	L2
29	-14,97	22,1	G2	73	-10,18	-6,3	L2
30	-14,97	25,3	E2	74	-10,18	6,3	-rect
31	Not assembled			75	-10,18	9,5	-rect
32	23,95	-11,82	U	76	-10,18	22,1	L3
33	23,95	-8,63	U	77	-10,18	25,3	L3
34	23,95	-5,42	E1	78	-53,82	-25,3	L1
35	-19,22	-25,3	G1	79	-53,82	-22,1	L1
36	Not assembled			80	Not assembled		
37	-19,7	-11,82	U	81	Not assembled		
38	-19,7	-8,62	U	82	-53,82	-9,5	L2
39	Not assembled			83	-53,82	-6,3	L2
40	17,74	-1	+B	84	Not assembled		
41	17,74	2,2	+B	85	-53,82	6,3	-rect
42	-22,67	22,1	-DC	86	-53,82	9,5	-rect
43	-22,67	25,3	-DC	87	-53,82	22,1	L3
44	-25,9	-1	+B	88	-53,82	25,3	L3



Pad positions refers to center point. For more informations on pad design please see package data




Identification					
ID	Component	Voltage	Current	Function	Comment
T1 - T6	IGBT	1200 V	100 A	Inverter Switch	
D1 - D6	FWD	1200 V	100 A	Inverter Diode	
T7	Rectifier	1200 V	100 A	Brake Switch	
D7	PTC	1200 V	100 A	Brake Diode	
D8 - D13	Rectifier	1600 V	75 A	Rectifier diode	
PTC1	PTC			Thermistor	



Packaging instruction			
Standard packaging quantity (SPQ)	48	>SPQ Standard	<SPQ Sample

Handling instruction
Handling instructions for MiniSkiiP [®] 3 packages see vincotech.com website.

Package data
Package data for MiniSkiiP [®] 3 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
V23990-K420-A40-D3-14	28 Jan. 2018	Updated with HPTP	all

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